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CENTRAL FAX CENTER

Application Serial No. 10/516,379 Reply to Office Action of December 12, 2007

JUN 17 2008

PATENT Docket: CU-3989

Amendments to the Claims

The listing of claims presented below replaces all prior versions, and listings, of claims in the application.

Listing of claims:

1-16. (cancelled)

17. (previously presented) A method for manufacturing[[, the]] <u>a</u> decorative material according to claim 13, wherein the ionizing radiation curing resin composition, <u>containing an ionizing radiation curing resin and a delustering silica</u> which is a silica whose surface is treated with a fatty acid based wax, is <u>coated on a base material sheet formed into the luster adjusting resin layer</u>, with no selvent, by using a doctor blade and a gravure plate <u>to form a luster adjusting resin layer</u> (on the base material).

18-26. (cancelled)

- 27. (new) The method for manufacturing a decorative material according to claim 17, wherein the ionizing radiation curing resin composition contains no solvent.
- 28. (new) The method for manufacturing a decorative material according to claim 17, wherein an amount of the declustering silica contained in the ionizing radiation curing resin composition is in a range of 5 parts by mass to 20 parts by mass to 100 parts by mass of the ionizing radiation curing resin.
- 29. (new) The method for manufacturing a decorative material according to claim 27, wherein an amount of the declustering silica contained in the ionizing radiation curing resin composition is in a range of 5 parts by mass to 20 parts by mass to 100 parts by mass of the ionizing radiation curing resin.
- 29. (new) The method for manufacturing a decorative material according to claim 18, wherein the luster adjusting resin layer is formed in pattern on the base material sheet.

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30. (new) The method for manufacturing a decorative material according to claim 19, wherein the luster adjusting resin layer is formed in pattern on the base material sheet.